

MOSFET

OptiMOS[™] 6 Power-Transistor, 135 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM) Very low reverse recovery charge (Q_{rr})
- 100% avalanche tested
- 175°C operating temperature
- Optimized for motor drives and battery powered applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

- MSL 1 classified according to J-STD-020

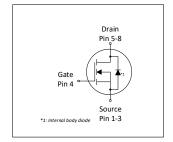


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Rey 1 of termanou 1 aramotore							
Parameter	Value	Unit					
$V_{ t DS}$	135	V					
$R_{ extsf{DS(on),max}}$	14.3	mΩ					
I _D	54	A					
Qoss	37	nC					
Q _G (0V10V)	21	nC					
Q _{rr} (500A/μs)	54	nC					











Type / Ordering Code	Package	Marking	Related Links
ISZ143N13NM6	PG-TSDSON-8 FL	14313N6	-

OptiMOS[™] 6 Power-Transistor, 135 V



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OptiMOS[™] 6 Power-Transistor, 135 V **ISZ143N13NM6**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatas	Cumbal		Value	S			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - - -	- - -	54 38 35 8.7	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =60 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	216	Α	T _C =25 °C	
Avalanche current, single pulse4)	I _{AS}	-	-	20	Α	T _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	116	mJ	I_D =8 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	95 2.5	W	T _C =25 °C T _A =25 °C, R _{THJA} =60 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	1.6	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Or work of		Values	3		Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	135	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.5	3.0	3.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=35\ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	1 10	10 100	μΑ	V _{DS} =108 V, V _{GS} =0 V, T _j =25 °C V _{DS} =108 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	- - -	11.6 12.4 13.2	13.6 14.3 17.0	mΩ	V _{GS} =15 V, I _D =20 A V _{GS} =10 V, I _D =20 A V _{GS} =8 V, I _D =10 A	
Gate resistance ¹⁾	R _G	-	0.8	1.2	Ω	-	
Transconductance ¹⁾	g fs	20	39	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$	

Table 5 **Dynamic characteristics**

Page 44 and	0		Values			Note / Tool Oos differen
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	1400	1800	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	290	380	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	7.3	13	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	7.6	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4.5	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	11	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4.4	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Davamatav	Cumbal		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge ¹⁾	Q _{gs}	-	6.2	8.1	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	4.2	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	4.5	6.8	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	6.5	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Q g	-	21	27	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	19	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V	
Output charge ¹⁾	Qoss	_	37	48	nC	V _{DS} =68 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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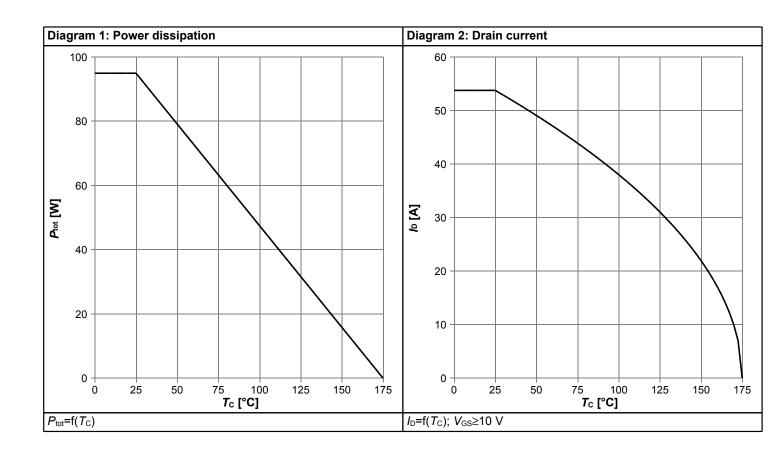


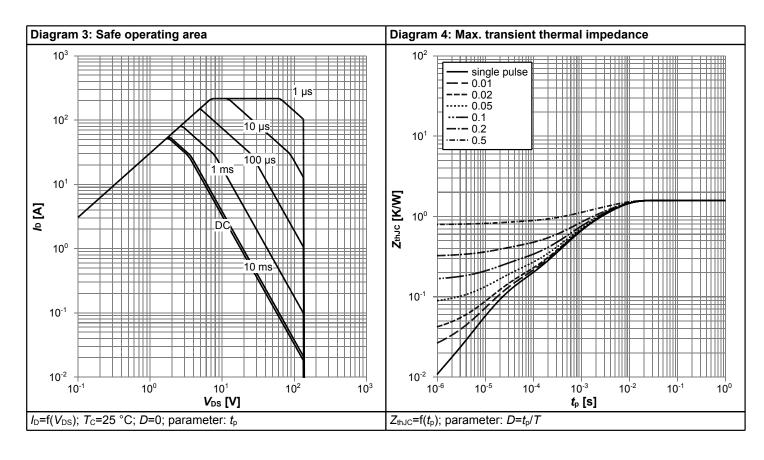
Table 7 Reverse diode

Developer	Cumbal		Values			Nets / Test Osmalities
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	54	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	216	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.86	1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	19	38	ns	V _R =68 V, I _F =10 A, di _F /dt=500 A/μs
Reverse recovery charge ¹⁾	Qrr	-	54	108	nC	V _R =68 V, I _F =10 A, di _F /dt=500 A/μs

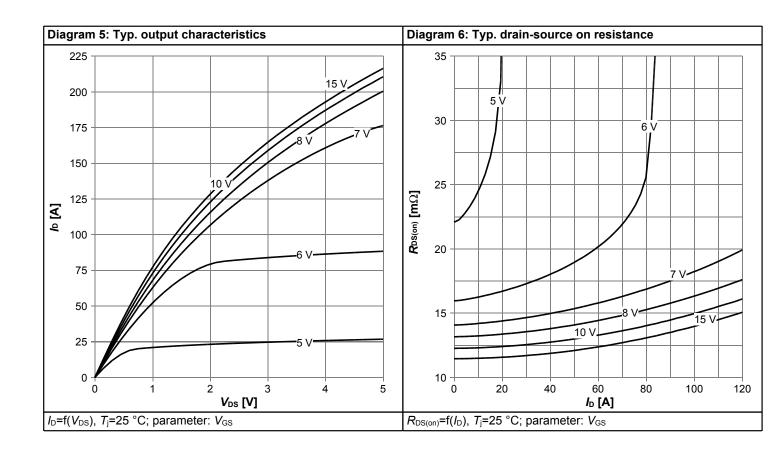


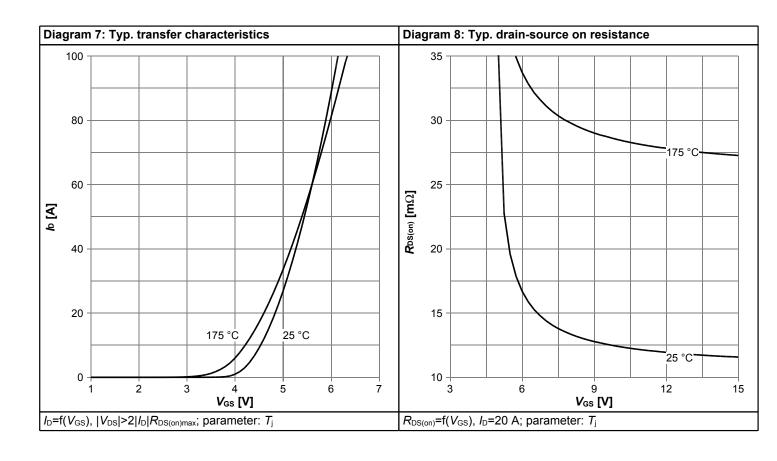
4 Electrical characteristics diagrams



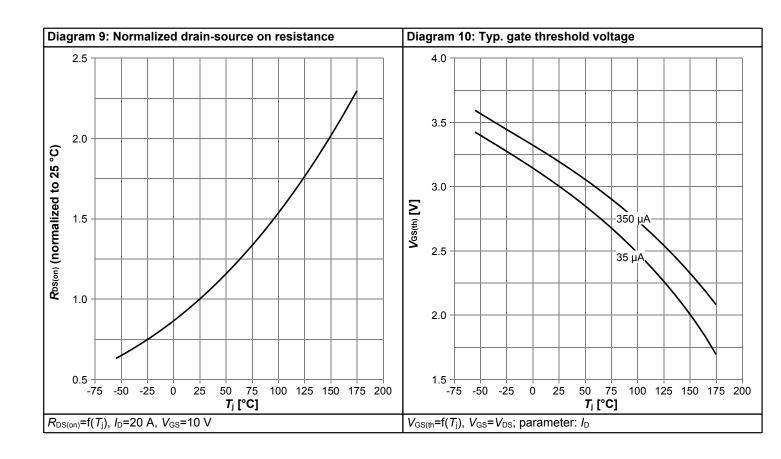


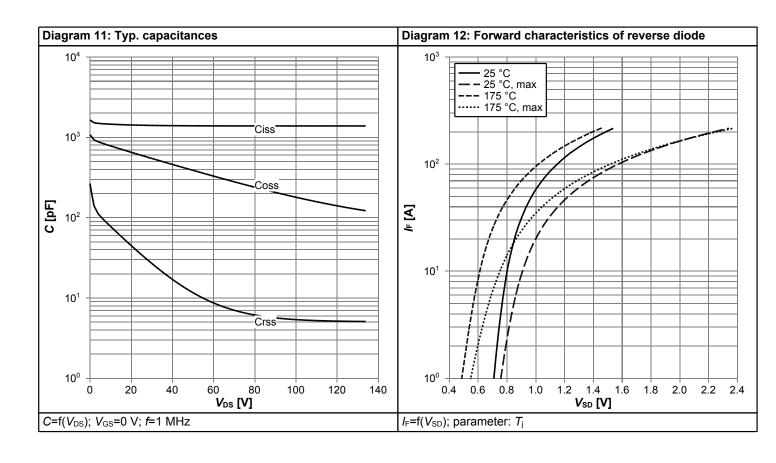




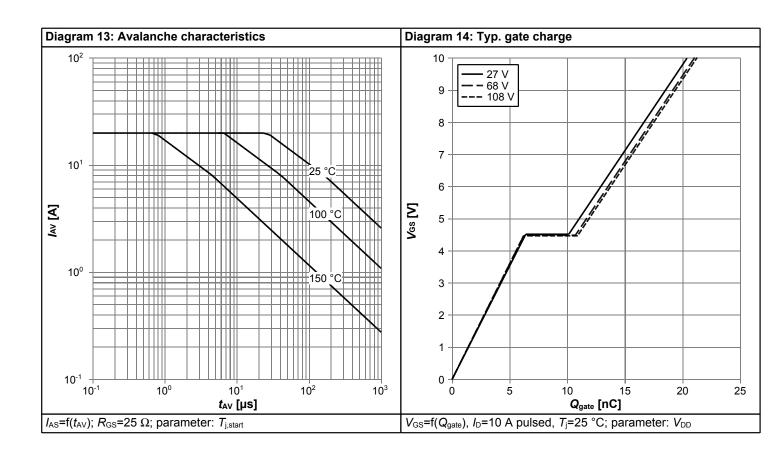


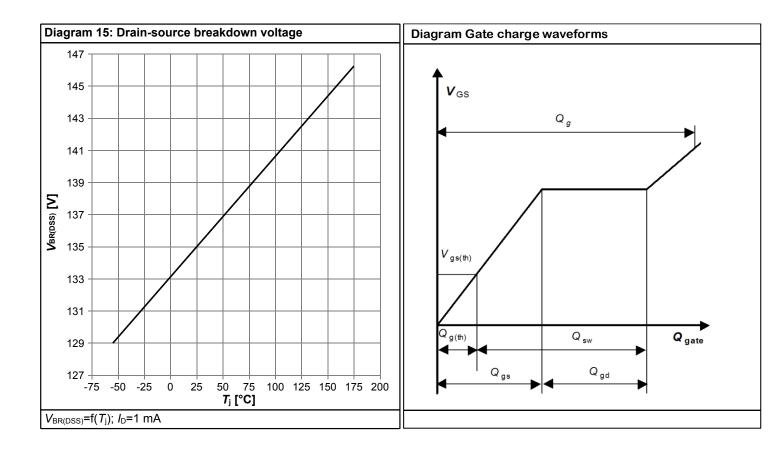






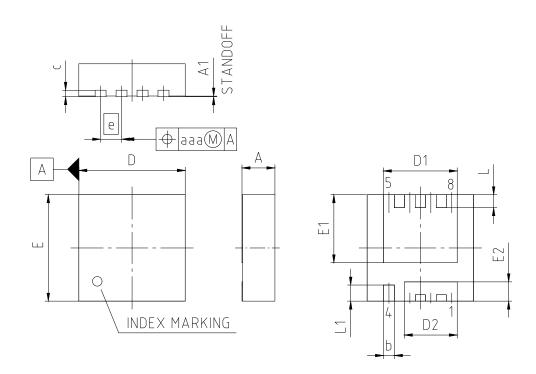








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDSON-8-U03						
DIMENSIONS	MILLIMETERS						
DIMENSIONS	MIN.	MAX.					
Α	0.90	1.10					
A1	0	0.05					
b	0.24	0.44					
С	0.10	0.30					
D	3.20	3.40					
D1	2.19	2.39					
D2	1.54	1.74					
E	3.20	3.40					
E1	2.01	2.21					
E2	0.50	0.70					
е	0.65						
L	0.30	0.50					
L1	0.40	0.60					
aaa	0.06						
N	8						

NOTE:

DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

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Revision History

ISZ143N13NM6

Revision: 2023-10-16, Rev. 2.0

Previous Revision

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Revision	Date	Subjects (major changes since last revision)			
2.0	2023-10-16	Release of final version			

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